60V N-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V_{(BR)DSS}$ = 60V; $R_{DS(ON)}$ = 0.14 Ω I_D = 2.7A

DESCRIPTION

This new generation of TRENCH MOSFETs from Zetex utilises a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.



S08

FEATURES

- Low on-resistance
- · Fast switching speed
- · Low threshold
- Low gate drive
- Low profile SO8 package

APPLICATIONS

- DC DC Converters
- Power Management Functions
- Disconnect switches
- Motor control

G1 G2 S2 S2

ORDERING INFORMATION

DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZXMN6A11DN8TA	7″	12mm	500 units
ZXMN6A11DN8TC	13"	12mm	2500 units



DEVICE MARKING

ZXMN 6A11D

Top View



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DSS}	60	V
Gate Source Voltage	V _{GS}	±20	V
Continuous Drain Current $V_{GS}=10V$; $T_A=25^{\circ}C(b)$ $V_{GS}=10V$; $T_A=70^{\circ}C(b)$ $V_{GS}=10V$; $T_A=25^{\circ}C(a)$	ID	2.7 2.2 2.1	А
Pulsed Drain Current (c)	I _{DM}	8.3	Α
Continuous Source Current (Body Diode) (b)	IS	3.2	Α
Pulsed Source Current (Body Diode)(c)	I _{SM}	8.3	Α
Power Dissipation at T _A =25°C (a)(d) Linear Derating Factor	PD	1.25 10	mW mW/°C
Power Dissipation at TA=25°C (a)(e) Linear Derating Factor	PD	1.8 14	mW mW/°C
Power Dissipation at T _A =25°C (b)(d) Linear Derating Factor	PD	2.1 17	mW mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +150	°C

THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)(d)	$R_{\theta JA}$	100	°C/W
Junction to Ambient (a)(e)	$R_{\theta JA}$	70	°C/W
Junction to Ambient (b)(d)	$R_{\theta JA}$	60	°C/W

NOTES



⁽a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions

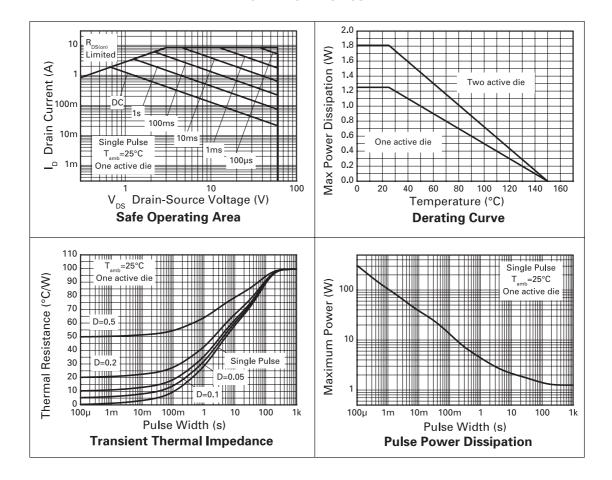
⁽b) For a device surface mounted on FR4 PCB measured at t≤10 secs.

⁽c) Repetitive rating $25mm \times 25mm$ FR4 PCB, D=0.05 pulse width= 10μ s - pulse width limited by maximum junction temperature.

⁽d) For device with one active die

⁽e) For device with two active die running at equal power.

CHARACTERISTICS





ELECTRICAL CHARACTERISTICS (at TA = 25°C unless otherwise stated)

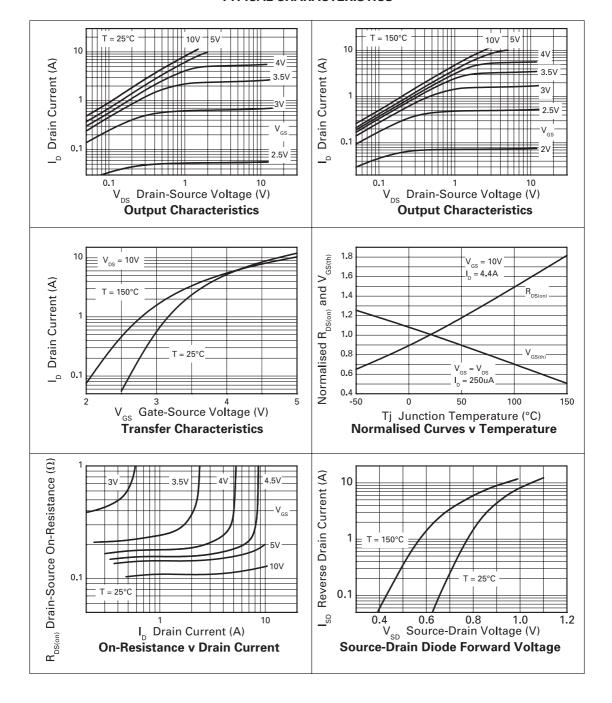
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
STATIC	'				•	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	60			V	I _D =250μA, V _{GS} =0V
Zero Gate Voltage Drain Current	I _{DSS}			1	μΑ	V _{DS} =60V, V _{GS} =0V
Gate-Body Leakage	I _{GSS}			100	nA	V_{GS} = $\pm 20V$, V_{DS} = $0V$
Gate-Source Threshold Voltage	V _{GS(th)}	1.0			V	I _D =250μA, V _{DS} = V _{GS}
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.14 0.25	Ω	V _{GS} =10V, I _D =4.4A V _{GS} =4.5V, I _D =3.8A
Forward Transconductance (3)	9fs		4.9		S	V _{DS} =15V,I _D =2.5A
DYNAMIC (3)	•					
Input Capacitance	C _{iss}		330		pF	
Output Capacitance	Coss		35.0		pF	V _{DS} =40 V, V _{GS} =0V, f=1MHz
Reverse Transfer Capacitance	C _{rss}		17.0		pF	
SWITCHING(2) (3)						
Turn-On Delay Time	t _{d(on)}		1.95		ns	V _{DD} =15V, I _D =2.5A R _G =6.0Ω,V _{GS} =10V (refer to test circuit)
Rise Time	t _r		3.5		ns	
Turn-Off Delay Time	td(off)		8.2		ns	
Fall Time	t _f		4.6		ns	
Gate Charge	Q_g		3.0		nC	V _{DS} =15V, V _{GS} =5V,
						I _D =2.5A
Total Gate Charge	Ωg		5.7		nC	V _{DS} =15V,V _{GS} =10V, I _D =2.5A (refer to test circuit)
Gate-Source Charge	Ogs		1.25		nC	
Gate-Drain Charge	Ω _{gd}		0.86		nC	
SOURCE-DRAIN DIODE						
Diode Forward Voltage (1)	V _{SD}		0.85	0.95	V	T _J =25°C, I _S =2.8A, V _{GS} =0V
Reverse Recovery Time (3)	t _{rr}		21.5		ns	T _J =25°C, I _F =2.5A, di/dt= 100A/μs
Reverse Recovery Charge (3)	Q _{rr}		20.5		nC	



Measured under pulsed conditions. Width≤300μs. Duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.

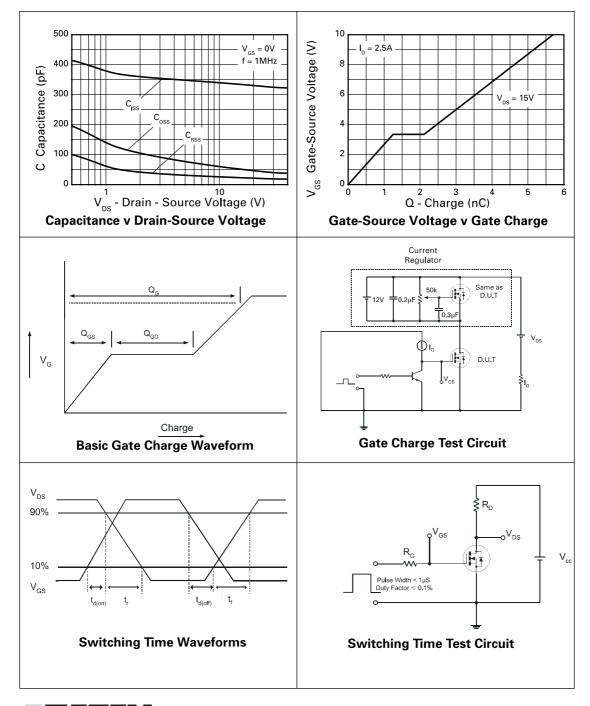
⁽³⁾ For design aid only, not subject to production testing.

TYPICAL CHARACTERISTICS



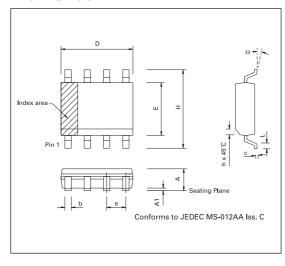


TYPICAL CHARACTERISTICS





PACKAGE OUTLINE



PACKAGE DIMENSIONS

DIM	INCHES			
DIM	MIN	MAX		
Α	0.053	0.069		
A1	0.004	0.010		
D	0.189	0.197		
Н	0.228	0.244		
Е	0.150	0.157		
L	0.016	0.050		
е	0.050 BSC			
b	0.013	0.020		
С	0.008	0.010		
θ	0°	8°		
h	0.010	0.020		

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